

RoHS

COMPLIANT

## N-Channel 30-V (D-S) MOSFET

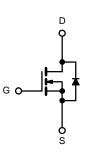
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.008 at V <sub>GS</sub> = 10 V	13	6.1 nC		
30	0.011 at V <sub>GS</sub> = 4.5 V	11	0.1110		

#### **FEATURES**

- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- Optimized for High-Side Synchronous • **Rectifier Operation**
- 100 % Rg Tested
- 100 % UIS Tested ٠

#### **APPLICATIONS**

 Notebook CPU Core - High-Side Switch



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	I <sub>D</sub>	13 10 9 <sup>b, c</sup> 7 <sup>b, c</sup>			
Pulsed Drain Current		I <sub>DM</sub>	45	— A		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.7 2.0 <sup>b, c</sup>			
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20			
Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	21	mJ		
Maximum Power Dissipation	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	P <sub>D</sub>	4.1 2.5 2.2 <sup>b, c</sup> 1.3 <sup>b, c</sup>	W		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			

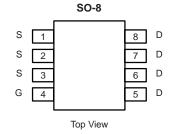
THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	55	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	25	29	0/11

Notes:

a. Base on T<sub>C</sub> = 25 °C. b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.



<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted							
Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
				-			
V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V		
$\Delta V_{DS}/T_{J}$	lo = 250 µA		26		mV/°C		
$\Delta V_{GS(th)}/T_J$	1 <u>0</u> – 200 μ/ (		- 6				
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0	V		
I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 20 V$			± 100	nA		
lace	$V_{DS} = 30 V, V_{GS} = 0 V$			1	μA		
'DSS	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10			
I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			А		
D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.008	008			
RDS(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		0.011		Ω		
9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		50		S		
11				<u> </u>	1		
C <sub>iss</sub>			800		pF		
	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		165				
			73				
	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		15	23	nC		
Qg			6.8	10.2			
Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 10 \text{ A}$		2.5				
Q <sub>gd</sub>			2.3				
R <sub>g</sub>	f = 1 MHz	0.36	1.8	3.6	Ω		
t <sub>d(on)</sub>			16	23			
t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.4 $\Omega$		12	16			
t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 9 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		16	22			
t <sub>f</sub>			10	18			
t <sub>d(on)</sub>			8	16	ns		
t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.4 $\Omega$		10	20	-		
t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 9 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		16	22			
t <sub>f</sub>			8	15			
ics				<u> </u>	1		
ا <sub>S</sub>	T <sub>C</sub> = 25 °C			10	٨		
I <sub>SM</sub>				50	A		
V <sub>SD</sub>	I <sub>S</sub> = 9 A		0.8	1.2	V		
t <sub>rr</sub>			15	30	ns		
			6	12	nC		
t <sub>a</sub>	ι <sub>F</sub> = 9 A, di/dt = 100 A/μs, 1 <sub>J</sub> = 25 °C		8		1		
t <sub>b</sub>			7		ns		
	$\begin{tabular}{ c c c } \hline Symbol \\ \hline V_{DS} \\ \hline \Delta V_{DS}/T_J \\ \hline \Delta V_{GS(th)}/T_J \\ \hline V_{GS(th)}/T_J \\ \hline V_{GS(th)}/T_J \\ \hline V_{GS(th)}/T_J \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline I_{DSS} \\ \hline I_{D(on)} \\ \hline R_{DS(on)} \\ \hline R_{DS(on)} \\ \hline R_{DS(on)} \\ \hline R_{Ciss} \\ \hline C_{iss} \\ \hline R_{g} \\ \hline C_{iss} \\ \hline C_{iss} \\ \hline R_{g} \hline R_{g} \\ \hline R_{g} \\ \hline R_{g} \hline R_{g} \hline R_{g} \\ \hline R_{g} $	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 10 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 10 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 10 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & I_D = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & I_D = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & I_D = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 10 \ A \\ \hline Q_{DD} = 15 \ V, \ R_L = 1.4 \ \Omega \\ \hline I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & V_{DD} = 15 \ V, \ R_L = 1.4 \ \Omega \\ \hline I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \equiv 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_D \equiv 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_T & I_T \\ \hline I_T & I_T & I_T \ I_T = 9 \ A, \ M_{I_T} = 9 \ A, \ M_{I_T} = 25 \ ^{\circ}C \\ \hline I_{SM} & I_T = 9 \ A, \ M_{I_T} = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline V_{SD} & I_S = 9 \ A \\ \hline V_{SD} & I_S = $	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 1.0 \\ \hline \Delta V_{GS}(th)/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.0 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.0 \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & T_J = 55 \ ^{\circ}C & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 100 \ P_{DS} = 50 \ V, \ V_{GS} = 10 \ V & 100 \ P_{DS} = 15 \ V, \ V_{GS} = 10 \ V & 100 \ P_{SS} & V_{DS} = 15 \ V, \ V_{DS} = 15 \ V, \ V_{DS} = 10 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ V_{CS} = 10 \ V, \ I_D = 10 \ A & V_{DD} = 15 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 15 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 15 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V, \ R_J = 1.4 \ \Omega & V_{DD} = 10 \ V_{DD} & V_{DD} = 10 \ V, \ R_J = 1.4 \ U_{D} & V_{DD} = 10 \ V, \ R_J = 1.4 $	$\begin{tabular}{ c c c c c c } \hline $\mathbf{Y}_{DS}$ & $V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A$ & $30$ & $$$$$$$$$$$$$$$$$$$$$$$$$$$$$$	$\begin{tabular}{ c c c c c c } \hline Symbol & Test Conditions & Min. Typ. Max. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 & 26 & 26 & 26 & 26 & 26 & 26 & 26 & 2$		

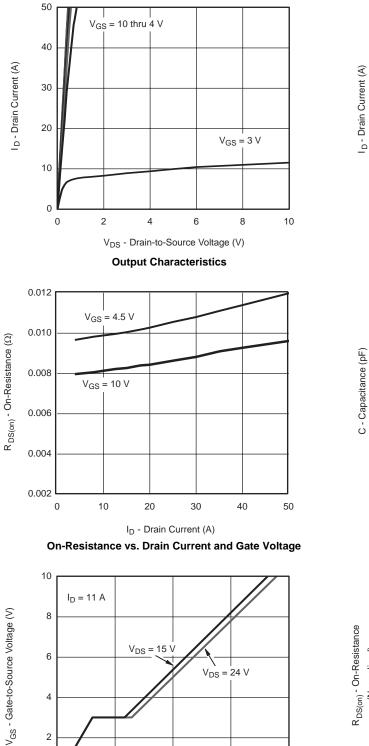
emi

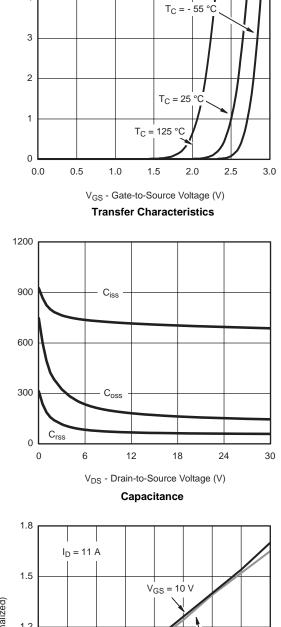
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

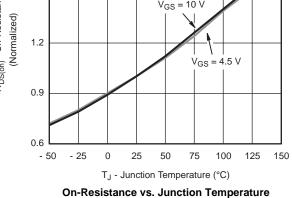
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





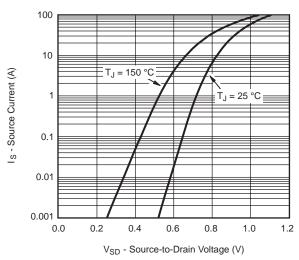


Q<sub>q</sub> - Total Gate Charge (nC)

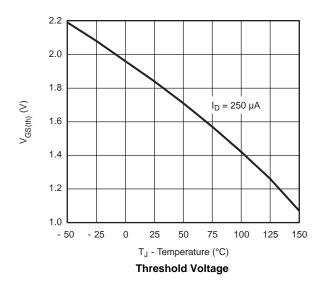
**Gate Charge** 

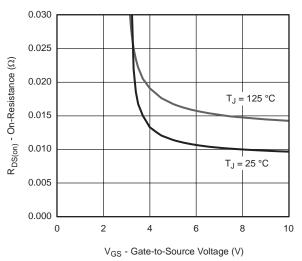


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

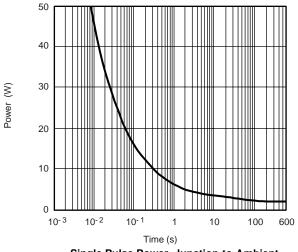




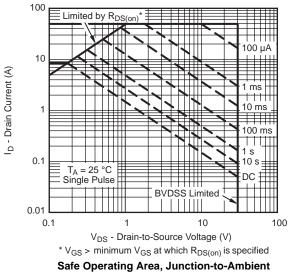




On-Resistance vs. Gate-to-Source Voltage

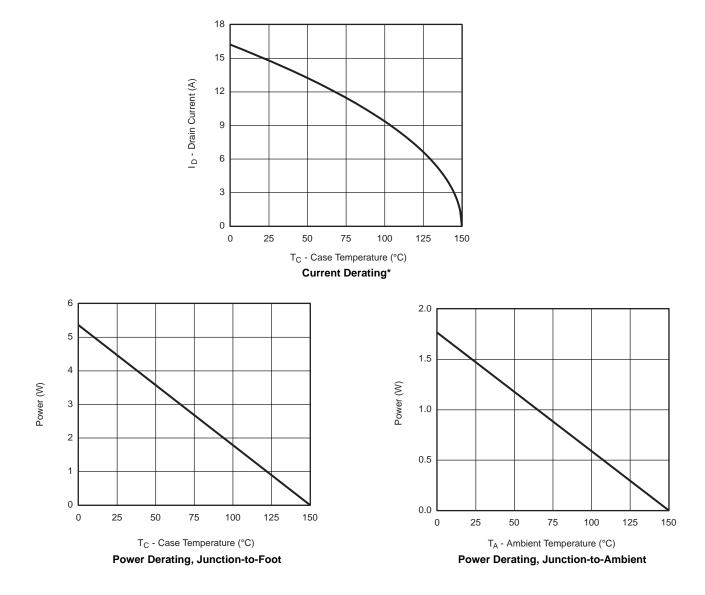


Single Pulse Power, Junction-to-Ambient



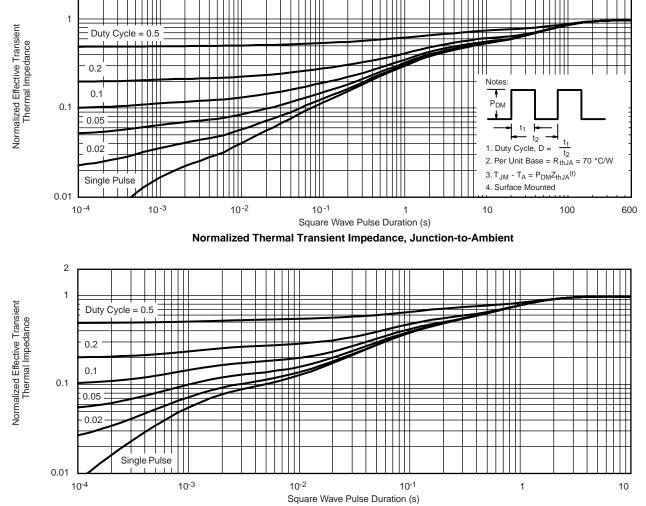


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

2



Bsemi

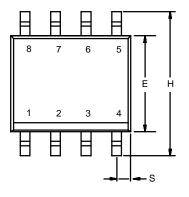
www.VBsemi.tw

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot



### SOIC (NARROW): 8-LEAD

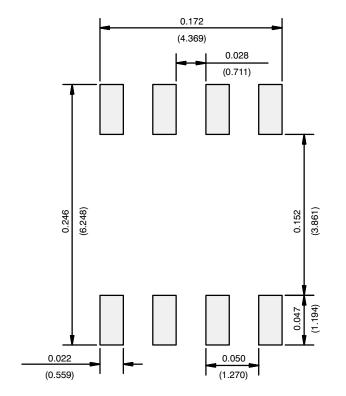




	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



# Disclaimer

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